

P-Channel 100 V (D-S) MOSFET

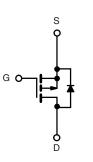
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 100	0.215 at V_{GS} = - 10 V	- 12	11		
- 100	0.234 at V _{GS} = - 4.5 V	- 10	11		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET ٠
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters •



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_{C} = 25 °C, unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 100	v		
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C	1-	- 12		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _C = 70 °C	I _D	- 8	٨	
Pulsed Drain Current	I _{DM}	- 30	- A		
Avalanche Current		I _{AS}	- 20		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	16.2	mJ	
	T _C = 25 °C	Р	32.1 ^b	14/	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.5	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

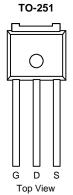
THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	0/11	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



E-mail: China@VBsemi TEL:86-755-83251052



FREE

SPECIFICATIONS $T_J = 25^{\circ}$	C, unless o	therwise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · ·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_D = -250 \mu A$	- 100			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50		
		V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 150 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 15			А	
	Р	V _{GS} = - 10 V, I _D = - 3.6 A		0.215		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.234			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1055		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65			
Reverse Transfer Capacitance	C _{rss}			41			
T + + O + O + O	Qg	V_{DS} = - 50 V, V_{GS} = - 10 V, I_D = - 3.6 A		23		nC	
Total Gate Charge ^c				11			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 50 V, V_{GS} = - 4.5 V, I_{D} = - 3.6 A		3.5			
Gate-Drain Charge ^c	Q _{gd}			4.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 50 V, R_L = 17.2 Ω		12	18	20	
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong$ - 2.9 A, $\rm V_{GEN}$ = - 10 V, $\rm R_g$ = 1 Ω		33	50	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings a	nd Characteri	stics $T_C = 25 \ ^{\circ}C^b$					
Continuous Current	ا _S				- 8.8	Α	
Pulsed Current	I _{SM}			T	- 15		
Forward Voltage ^a	V _{SD}	$I_{F} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	А	
Reverse Recovery Charge	Q _{rr}] [98	147	nC	

Notes:

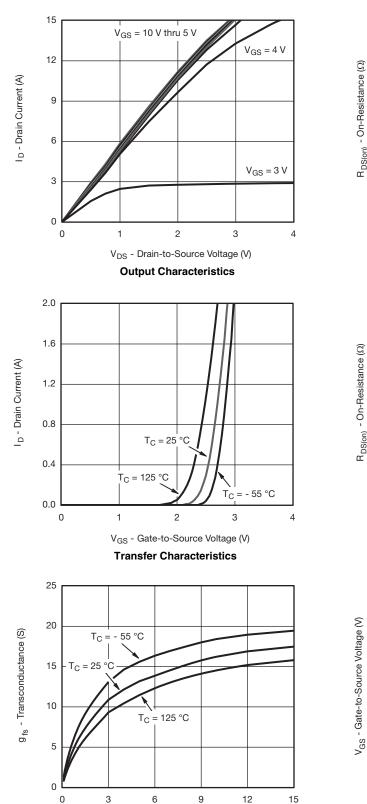
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

emi

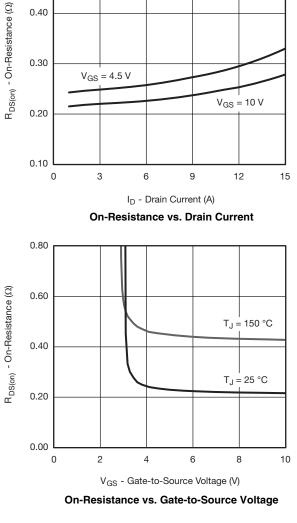




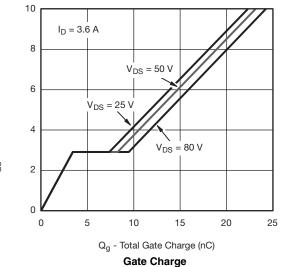
I_D - Drain Current (A)

Transconductance

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

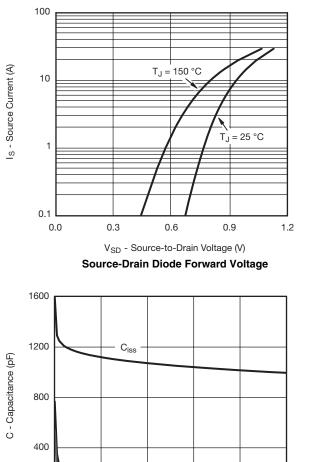


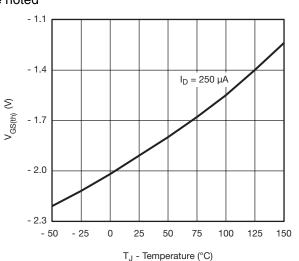
0.50



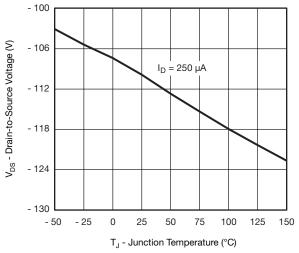


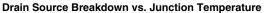
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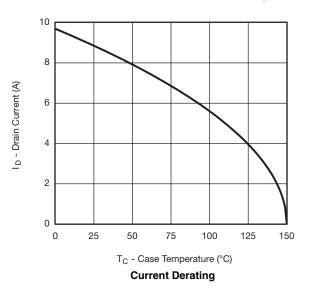


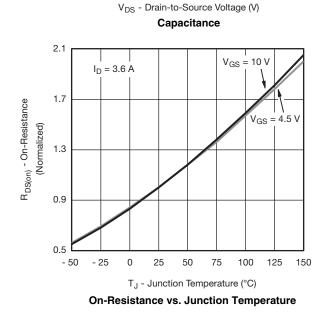


Threshold Voltage





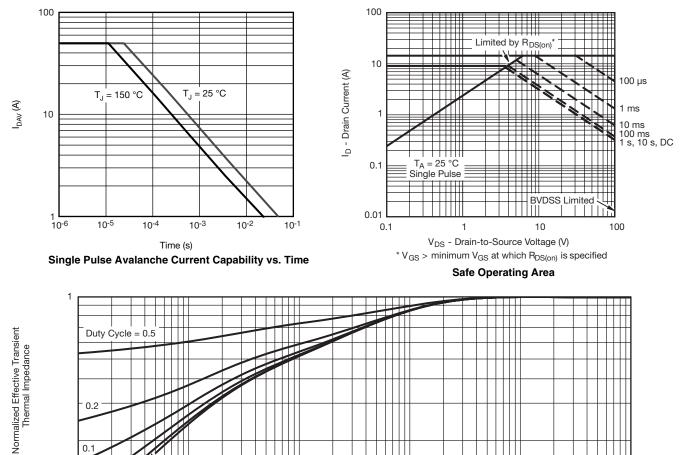




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



10-2

10-1

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

1

0.1

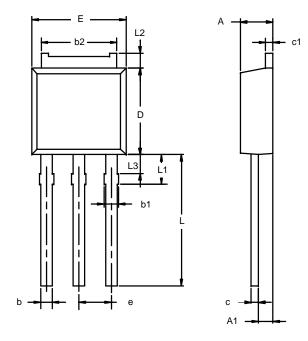
0.1 10⁻⁴ Single Pulse

10⁻³

10



TO-251AA (DPAK)



	MILLIM	MILLIMETERS INCHE		
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
c1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090 BSC	
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346				

Note: Dimension L3 is for reference only.



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